

# ADS7810

## 12-Bit 800kHz Sampling CMOS ANALOG-to-DIGITAL CONVERTER

### FEATURES

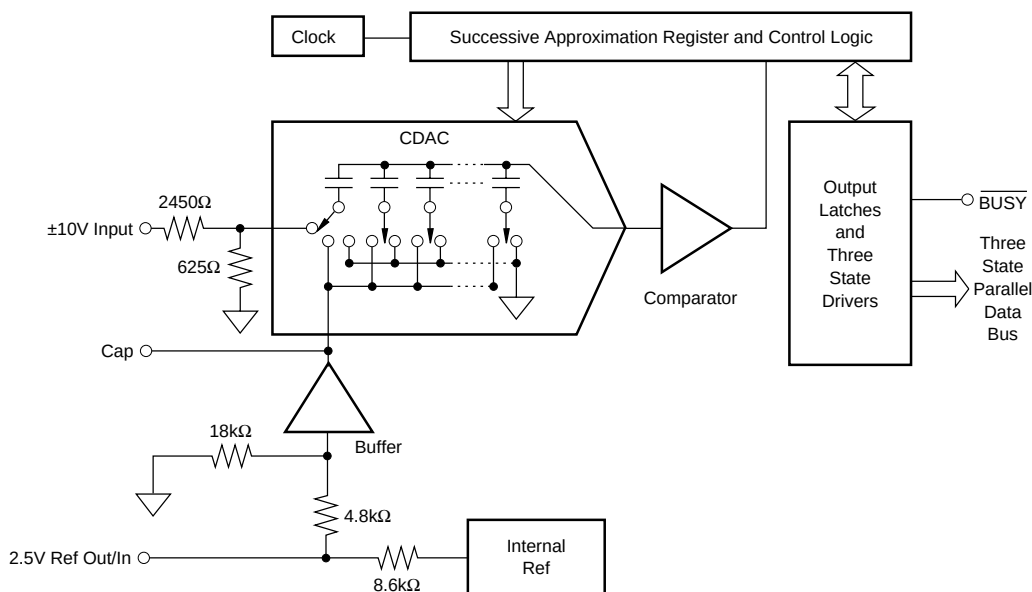
- 1.25 $\mu$ s THROUGHPUT TIME
- STANDARD  $\pm 10$ V INPUT RANGE
- 69dB min SINAD WITH 250kHz INPUT
- $\pm 3/4$  LSB max INL AND  $\pm 1$  LSB max DNL
- INTERNAL REFERENCE
- COMPLETE WITH S/H, REF, CLOCK, ETC.
- PARALLEL DATA w/LATCHES
- 28-PIN SOIC

### DESCRIPTION

The ADS7810 is a complete 12-bit sampling A/D using state-of-the-art CMOS structures. It contains a complete 12-bit capacitor-based SAR A/D with inherent S/H, reference, clock, interface for microprocessor use, and three-state output drivers.

The ADS7810 is specified at an 800kHz sampling rate, and guaranteed over the full temperature range. Laser-trimmed scaling resistors provide the industry-standard  $\pm 10$ V input range, while an innovative design allows operation from  $\pm 5$ V supplies.

The 28-pin ADS7810 is available in a plastic SOIC fully specified for operation over the industrial  $-40^{\circ}\text{C}$  to  $+85^{\circ}\text{C}$  range.



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## ELECTRICAL

| PARAMETER                                                 | CONDITIONS                                | ADS7810U |            |                      | ADS7810UB |     |       | UNITS              |
|-----------------------------------------------------------|-------------------------------------------|----------|------------|----------------------|-----------|-----|-------|--------------------|
|                                                           |                                           | MIN      | TYP        | MAX                  | MIN       | TYP | MAX   |                    |
| RESOLUTION                                                |                                           |          |            | 12                   |           |     | *     | Bits               |
| ANALOG INPUT                                              |                                           |          |            |                      |           |     |       |                    |
| Voltage Range                                             |                                           |          | ±10        |                      |           | *   |       | V                  |
| Impedance                                                 |                                           |          | 3.1        |                      |           | *   |       | kΩ                 |
| Capacitance                                               |                                           |          | 5          |                      |           | *   |       | pF                 |
| THROUGHPUT SPEED                                          |                                           |          |            |                      |           |     |       |                    |
| Conversion Cycle                                          | $t_3 + t_4$                               |          | 1020       |                      |           | *   |       | ns                 |
| Complete Cycle                                            | Acquire & Convert                         |          |            | 1250                 |           |     | *     | ns                 |
| Throughput Rate                                           |                                           | 800      |            |                      | *         |     |       | kHz                |
| DC ACCURACY                                               |                                           |          |            |                      |           |     |       |                    |
| Integral Linearity Error                                  |                                           |          |            | ±1                   |           |     | ±0.75 | LSB <sup>(1)</sup> |
| Differential Linearity Error                              |                                           |          |            | ±1                   |           |     | *     | LSB                |
| No Missing Codes                                          |                                           |          | Guaranteed |                      |           | *   |       |                    |
| Transition Noise <sup>(2)</sup>                           |                                           |          | 0.1        |                      |           | *   |       | LSB                |
| Full Scale Error <sup>(3, 4)</sup>                        |                                           |          |            | ±0.5                 |           |     | ±0.25 | %                  |
| Full Scale Error Drift                                    |                                           |          | ±12        |                      |           | *   |       | ppm/°C             |
| Full Scale Error <sup>(3, 4)</sup>                        | Ext. 2.5000V Ref                          |          |            | ±0.5                 |           |     | *     | %                  |
| Full Scale Error Drift                                    | Ext. 2.5000V Ref                          |          | ±12        |                      |           | *   |       | ppm/°C             |
| Bipolar Zero Error <sup>(3)</sup>                         |                                           |          |            | ±8                   |           |     | ±4    | LSB                |
| Bipolar Zero Error Drift                                  |                                           |          | ±2         |                      |           | *   |       | ppm/°C             |
| Power Supply Sensitivity                                  |                                           |          |            |                      |           |     |       |                    |
| (+V <sub>DIG</sub> = +V <sub>ANA</sub> = V <sub>D</sub> ) | +4.75V < V <sub>D</sub> < +5.25V          |          |            | ±5                   |           |     | *     | LSB                |
|                                                           | −5.25V < −V <sub>ANA</sub> < −4.75V       |          |            | ±0.5                 |           |     | *     | LSB                |
| AC ACCURACY                                               |                                           |          |            |                      |           |     |       |                    |
| Spurious-Free Dynamic Range                               | f <sub>IN</sub> = 250kHz                  | 74       | 82         |                      | 77        | 84  |       | dB <sup>(5)</sup>  |
| Total Harmonic Distortion                                 | f <sub>IN</sub> = 250kHz                  |          | −80        | −74                  |           | −82 | −77   | dB                 |
| Signal-to-(Noise+Distortion)                              | f <sub>IN</sub> = 250kHz                  | 67       | 71         |                      | 69        | *   |       | dB                 |
| Signal-to-Noise                                           | f <sub>IN</sub> = 250kHz                  | 68       | 71         |                      | 70        | *   |       | dB                 |
| Usable Bandwidth <sup>(6)</sup>                           |                                           |          | 1.5        |                      |           | *   |       | MHz                |
| SAMPLING DYNAMICS                                         |                                           |          |            |                      |           |     |       |                    |
| Aperture Delay                                            |                                           |          | 20         |                      |           | *   |       | ns                 |
| Aperture Jitter                                           |                                           |          | 10         |                      |           | *   |       | ps                 |
| Transient Response                                        | FS Step                                   |          | 200        |                      |           | *   |       | ns                 |
| Overvoltage Recovery <sup>(7)</sup>                       |                                           |          | 250        |                      |           | *   |       | ns                 |
| REFERENCE                                                 |                                           |          |            |                      |           |     |       |                    |
| Internal Reference Voltage                                |                                           | 2.48     | 2.5        | 2.52                 | *         | *   | *     | V                  |
| Internal Reference DC Source Current                      |                                           |          | 100        |                      |           | *   |       | μA                 |
| (External load should be static)                          |                                           |          |            |                      |           |     |       |                    |
| Internal Reference Drift                                  |                                           |          | 8          |                      |           |     |       | ppm/°C             |
| External Reference Voltage Range                          |                                           | 2.3      | 2.5        | 2.7                  | *         | *   | *     | V                  |
| For Specified Linearity                                   |                                           |          |            |                      |           |     |       |                    |
| External Reference Current Drain                          | Ext. 2.5000V Ref                          |          |            | 100                  |           |     | *     | μA                 |
| DIGITAL INPUTS                                            |                                           |          |            |                      |           |     |       |                    |
| Logic Levels                                              |                                           |          |            |                      |           |     |       |                    |
| V <sub>IL</sub>                                           |                                           | −0.3     |            | +0.8                 | *         |     | *     | V                  |
| V <sub>IH</sub>                                           |                                           | +2.4     |            | V <sub>D</sub> + 0.3 | *         |     | *     | V                  |
| I <sub>IL</sub>                                           | V <sub>IL</sub> = 0V                      |          |            | ±10                  |           |     | *     | μA                 |
| I <sub>IH</sub>                                           | V <sub>IH</sub> = 5V                      |          |            | ±10                  |           |     | *     | μA                 |
| DIGITAL OUTPUTS                                           |                                           |          |            |                      |           |     |       |                    |
| Data Format                                               |                                           |          |            |                      |           |     |       |                    |
| Data Coding                                               |                                           |          |            |                      |           |     |       |                    |
| V <sub>OL</sub>                                           | I <sub>SINK</sub> = 1.6mA                 |          |            |                      |           |     | *     | V                  |
| V <sub>OH</sub>                                           | I <sub>SOURCE</sub> = 500μA               | +2.8     |            | +0.4                 | *         |     |       | V                  |
| Leakage Current                                           | High-Z State,                             |          |            | ±5                   |           |     | *     | μA                 |
|                                                           | V <sub>OUT</sub> = 0V to V <sub>DIG</sub> |          |            |                      |           |     |       |                    |
| Output Capacitance                                        | High-Z State                              |          |            | 15                   |           |     | 15    | pF                 |
| DIGITAL TIMING                                            |                                           |          |            |                      |           |     |       |                    |
| Bus Access Time                                           |                                           |          |            | 62                   |           |     | *     | ns                 |
| Bus Relinquish Time                                       |                                           |          |            | 83                   |           |     | *     | ns                 |

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# SPECIFICATIONS (CONT)

## ELECTRICAL

At  $T_A = -40^\circ\text{C}$  to  $+85^\circ\text{C}$ ,  $f_s = 800\text{kHz}$ ,  $+V_{\text{DIG}} = +V_{\text{ANA}} = +5\text{V}$ ,  $-V_{\text{ANA}} = -5\text{V}$ , using internal reference and the  $50\Omega$  input resistor shown in Figure 4b, unless otherwise specified.

| PARAMETER                                                                                                                                                                                                                                                                         | CONDITIONS            | ADS7810U |     |       | ADS7810UB |     |     | UNITS              |
|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|-----------------------|----------|-----|-------|-----------|-----|-----|--------------------|
|                                                                                                                                                                                                                                                                                   |                       | MIN      | TYP | MAX   | MIN       | TYP | MAX |                    |
| <b>POWER SUPPLIES</b><br>Specified Performance<br>$+V_{\text{DIG}} = +V_{\text{ANA}}$<br>$-V_{\text{ANA}}$<br>$+I_{\text{DIG}}$<br>$+I_{\text{ANA}}$<br>$-I_{\text{ANA}}$<br>Derated Performance<br>$+V_{\text{DIG}} = +V_{\text{ANA}}$<br>$-V_{\text{ANA}}$<br>Power Dissipation |                       | +4.75    | +5  | +5.25 | *         | *   | *   | V                  |
|                                                                                                                                                                                                                                                                                   |                       | -5.25    | -5  | -4.75 | *         | *   | *   | V                  |
|                                                                                                                                                                                                                                                                                   |                       |          | +16 |       |           | *   |     | mA                 |
|                                                                                                                                                                                                                                                                                   |                       |          | +16 |       |           | *   |     | mA                 |
|                                                                                                                                                                                                                                                                                   |                       |          | -13 |       |           | *   |     | mA                 |
|                                                                                                                                                                                                                                                                                   |                       | +4.5     | +5  | +5.5  | *         | *   | *   | V                  |
| <b>TEMPERATURE RANGE</b><br>Specified Performance<br>Derated Performance<br>Storage<br>Thermal Resistance ( $\theta_{JA}$ )<br>Plastic DIP<br>SOIC                                                                                                                                | $f_s = 800\text{kHz}$ | -40      |     | +85   | *         |     | *   | $^\circ\text{C}$   |
|                                                                                                                                                                                                                                                                                   |                       | -55      |     | +125  |           |     |     | $^\circ\text{C}$   |
|                                                                                                                                                                                                                                                                                   |                       | -65      |     | +150  | *         |     | *   | $^\circ\text{C}$   |
|                                                                                                                                                                                                                                                                                   |                       |          | 75  |       |           | *   |     | $^\circ\text{C/W}$ |
|                                                                                                                                                                                                                                                                                   |                       |          | 75  |       |           | *   |     | $^\circ\text{C/W}$ |
|                                                                                                                                                                                                                                                                                   |                       |          |     |       |           |     |     |                    |

\* Specification same as ADS7810U.

NOTES: (1) LSB means Least Significant Bit. For the 12-bit,  $\pm 10\text{V}$  input ADS7810, one LSB is 4.88mV. (2) Typical rms noise at worst case transitions and temperatures. (3) Measured with  $50\Omega$  in series with analog input. Adjustable to zero with external potentiometer. (4) Full scale error is the worst case of -Full Scale or +Full Scale untrimmed deviation from ideal first and last code transitions, divided by the transition voltage (not divided by the full-scale range) and includes the effect of offset error. (5) All specifications in dB are referred to a full-scale  $\pm 10\text{V}$  input. (6) Usable Bandwidth defined as Full-Scale input frequency at which Signal-to-(Noise+Distortion) degrades to 60dB, or 10 bits of accuracy. (7) Recovers to specified performance after  $2 \times \text{FS}$  input over voltage.

## ABSOLUTE MAXIMUM RATINGS

|                                                      |                                                         |
|------------------------------------------------------|---------------------------------------------------------|
| Analog Inputs: $V_{\text{IN}}$ .....                 | $\pm 25\text{V}$                                        |
| REF .....                                            | $+V_{\text{ANA}} + 0.3\text{V}$ to AGND2 $-0.3\text{V}$ |
| CAP .....                                            | Indefinite Short to AGND2                               |
|                                                      | Momentary Short to $+V_{\text{ANA}}$                    |
| Ground Voltage Differences: DGND, AGND1, AGND2 ..... | $\pm 0.3\text{V}$                                       |
| $+V_{\text{ANA}}$ .....                              | +7V                                                     |
| $+V_{\text{DIG}}$ to $+V_{\text{ANA}}$ .....         | +0.3V                                                   |
| $+V_{\text{DIG}}$ .....                              | 7V                                                      |
| $-V_{\text{ANA}}$ .....                              | -7V                                                     |
| Digital Inputs .....                                 | $-0.3\text{V}$ to $+V_{\text{DIG}} + 0.3\text{V}$       |
| Maximum Junction Temperature .....                   | $+165^\circ\text{C}$                                    |
| Internal Power Dissipation .....                     | 825mW                                                   |
| Lead Temperature (soldering, 10s) .....              | $+300^\circ\text{C}$                                    |



## ELECTROSTATIC DISCHARGE SENSITIVITY

This integrated circuit can be damaged by ESD. Burr-Brown recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage.

ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

## ORDERING/PACKAGE INFORMATION

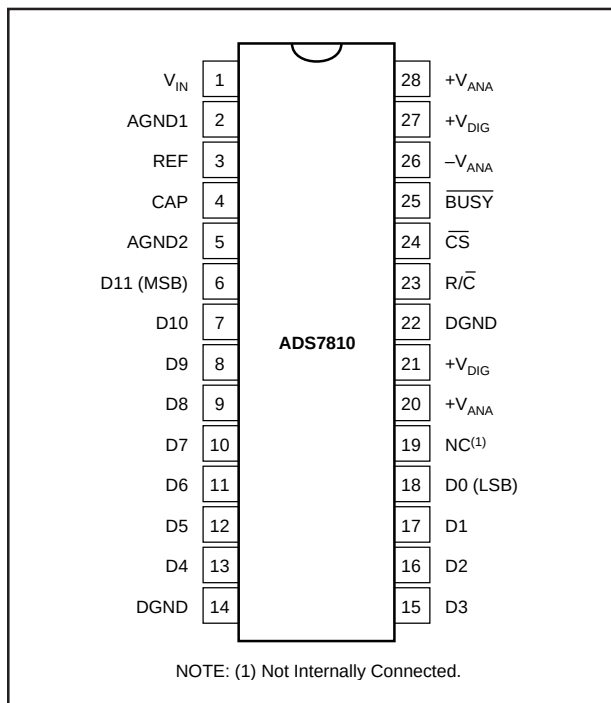
| PRODUCT   | MAXIMUM INTEGRAL LINEARITY ERROR (LSB) | MINIMUM SIGNAL-TO-(NOISE + DISTORTION) RATIO (dB) | SPECIFICATION TEMPERATURE RANGE            | PACKAGE     | PACKAGE DRAWING NUMBER <sup>(1)</sup> |
|-----------|----------------------------------------|---------------------------------------------------|--------------------------------------------|-------------|---------------------------------------|
| ADS7810U  | $\pm 1$                                | 67                                                | $-40^\circ\text{C}$ to $+85^\circ\text{C}$ | 28-Pin SOIC | 217                                   |
| ADS7810UB | $\pm 0.75$                             | 69                                                | $-40^\circ\text{C}$ to $+85^\circ\text{C}$ | 28-Pin SOIC | 217                                   |

NOTE: (1) For detailed drawing and dimension table, please see end of data sheet, or Appendix C of Burr-Brown IC Data Book.

## PIN ASSIGNMENTS

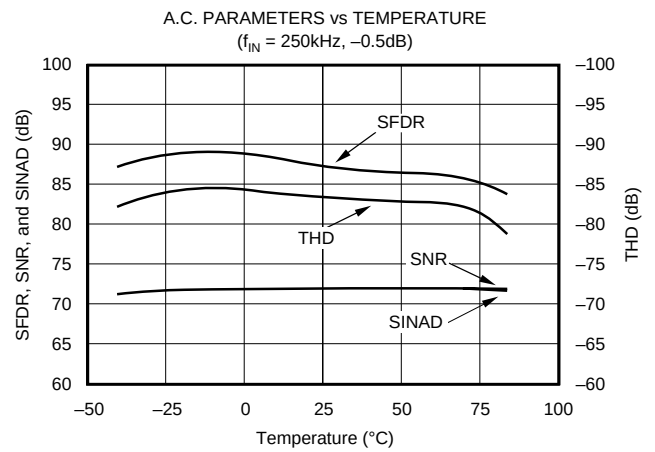
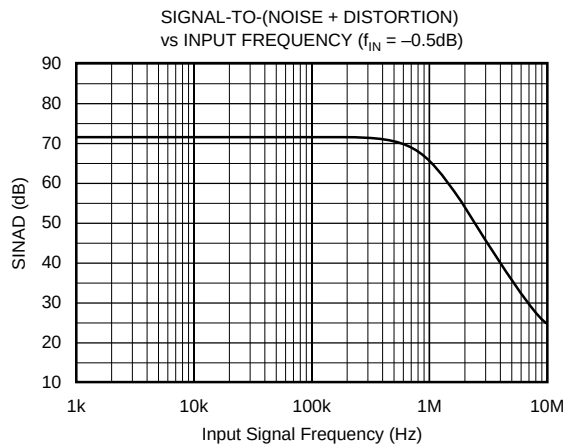
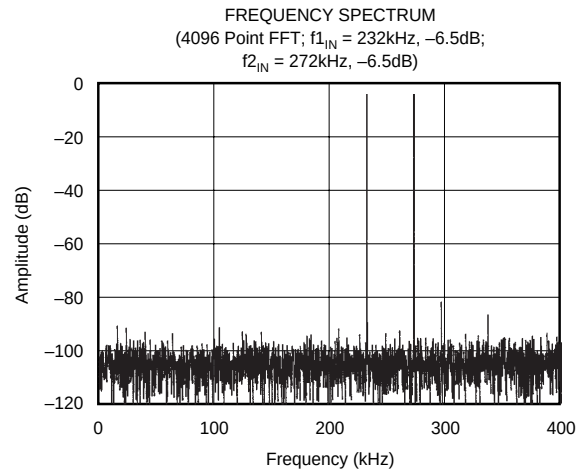
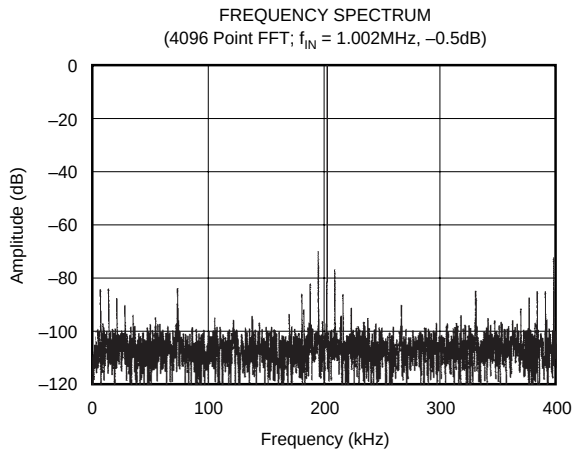
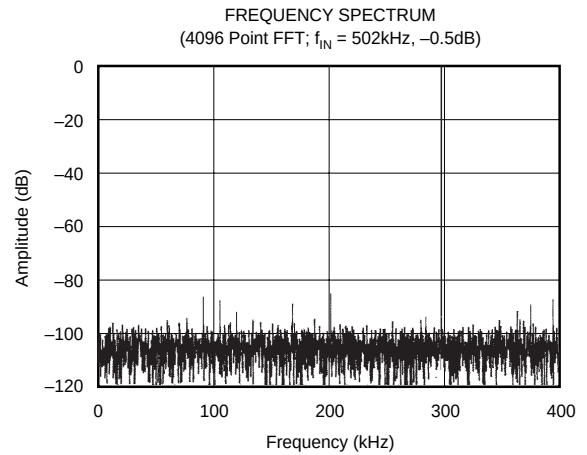
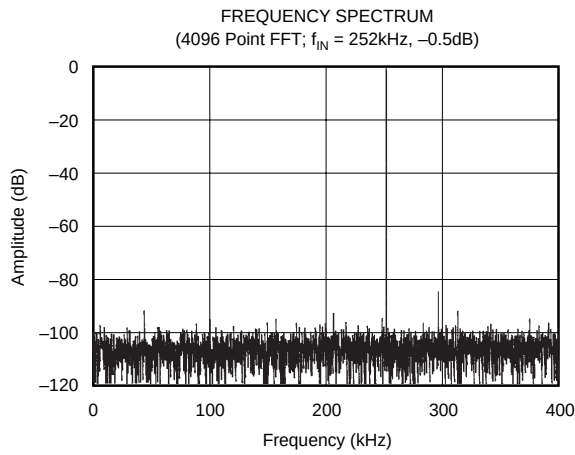
| PIN # | NAME              | DIGITAL I/O | DESCRIPTION                                                                                                                                                                                                                                                                                                             |
|-------|-------------------|-------------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 1     | V <sub>IN</sub>   |             | Analog Input. Connect via 50Ω to analog input. Full-scale input range is ±10V.                                                                                                                                                                                                                                          |
| 2     | AGND1             |             | Analog Ground. Used internally as ground reference point. Minimal current flow.                                                                                                                                                                                                                                         |
| 3     | REF               |             | Reference Input/Output. Outputs internal reference of +2.5V nominal. Can also be driven by external system reference. In both cases, decouple to ground with a 0.1μF ceramic capacitor.                                                                                                                                 |
| 4     | CAP               |             | Reference Buffer Output. 10μF tantalum capacitor to ground. Nominally +2V.                                                                                                                                                                                                                                              |
| 5     | AGND2             |             | Analog Ground.                                                                                                                                                                                                                                                                                                          |
| 6     | D11 (MSB)         | O           | Data Bit 11. Most Significant Bit (MSB) of conversion results. Hi-Z state when $\overline{CS}$ is HIGH, or when $R/\overline{C}$ is LOW, or when a conversion is in progress.                                                                                                                                           |
| 7     | D10               | O           | Data Bit 10. Hi-Z state when $\overline{CS}$ is HIGH, or when $R/\overline{C}$ is LOW, or when a conversion is in progress.                                                                                                                                                                                             |
| 8     | D9                | O           | Data Bit 9. Hi-Z state when $\overline{CS}$ is HIGH, or when $R/\overline{C}$ is LOW, or when a conversion is in progress.                                                                                                                                                                                              |
| 9     | D8                | O           | Data Bit 8. Hi-Z state when $\overline{CS}$ is HIGH, or when $R/\overline{C}$ is LOW, or when a conversion is in progress.                                                                                                                                                                                              |
| 10    | D7                | O           | Data Bit 7. Hi-Z state when $\overline{CS}$ is HIGH, or when $R/\overline{C}$ is LOW, or when a conversion is in progress.                                                                                                                                                                                              |
| 11    | D6                | O           | Data Bit 6. Hi-Z state when $\overline{CS}$ is HIGH, or when $R/\overline{C}$ is LOW, or when a conversion is in progress.                                                                                                                                                                                              |
| 12    | D5                | O           | Data Bit 5. Hi-Z state when $\overline{CS}$ is HIGH, or when $R/\overline{C}$ is LOW, or when a conversion is in progress.                                                                                                                                                                                              |
| 13    | D4                | O           | Data Bit 4. Hi-Z state when $\overline{CS}$ is HIGH, or when $R/\overline{C}$ is LOW, or when a conversion is in progress.                                                                                                                                                                                              |
| 14    | DGND              |             | Digital Ground.                                                                                                                                                                                                                                                                                                         |
| 15    | D3                | O           | Data Bit 3. Hi-Z state when $\overline{CS}$ is HIGH, or when $R/\overline{C}$ is LOW, or when a conversion is in progress.                                                                                                                                                                                              |
| 16    | D2                | O           | Data Bit 2. Hi-Z state when $\overline{CS}$ is HIGH, or when $R/\overline{C}$ is LOW, or when a conversion is in progress.                                                                                                                                                                                              |
| 17    | D1                | O           | Data Bit 1. Hi-Z state when $\overline{CS}$ is HIGH, or when $R/\overline{C}$ is LOW, or when a conversion is in progress.                                                                                                                                                                                              |
| 18    | D0 (LSB)          | O           | Data Bit 0. Least Significant Bit (LSB) of conversion results. Hi-Z state when $\overline{CS}$ is HIGH, or when $R/\overline{C}$ is LOW, or when a conversion is in progress.                                                                                                                                           |
| 19    |                   |             | Not internally connected.                                                                                                                                                                                                                                                                                               |
| 20    | +V <sub>ANA</sub> |             | Analog Positive Supply Input. Nominally +5V. Connect directly to pins 21, 27 and 28.                                                                                                                                                                                                                                    |
| 21    | +V <sub>DIG</sub> |             | Digital Supply Input. Nominally +5V. Connect directly to pins 20, 27 and 28.                                                                                                                                                                                                                                            |
| 22    | DGND              |             | Digital ground.                                                                                                                                                                                                                                                                                                         |
| 23    | R/ $\overline{C}$ | I           | Read/Convert Input. With $\overline{CS}$ LOW, a falling edge on $R/\overline{C}$ puts the internal sample/hold into the hold state and starts a conversion. With $\overline{CS}$ LOW and no conversion in progress, a rising edge on $R/\overline{C}$ enables the output data bits.                                     |
| 24    | $\overline{CS}$   | I           | Chip Select. With $R/\overline{C}$ LOW, a falling edge on $\overline{CS}$ will initiate a conversion. With $R/\overline{C}$ HIGH and no conversion in progress, a falling edge on $\overline{CS}$ will enable the output data bits.                                                                                     |
| 25    | $\overline{BUSY}$ | O           | Busy Output. Falls when a conversion is started, and remains LOW until the conversion is completed and the data is latched into the output register. With $\overline{CS}$ LOW and $R/\overline{C}$ HIGH, output data will be valid when $\overline{BUSY}$ rises, so that the rising edge can be used to latch the data. |
| 26    | -V <sub>ANA</sub> |             | Analog Negative Supply Input. Nominally -5V. Decouple to ground with 0.1μF ceramic and 10μF tantalum capacitors.                                                                                                                                                                                                        |
| 27    | +V <sub>DIG</sub> |             | Digital Supply Input. Nominally +5V. Connect directly to pins 20, 21 and 28.                                                                                                                                                                                                                                            |
| 28    | +V <sub>ANA</sub> |             | Analog Positive Supply Input. Nominally +5V. Connect directly to pins 20, 21 and 27, and decouple to ground with 0.1μF ceramic and 10μF tantalum capacitors.                                                                                                                                                            |

## PIN CONFIGURATION



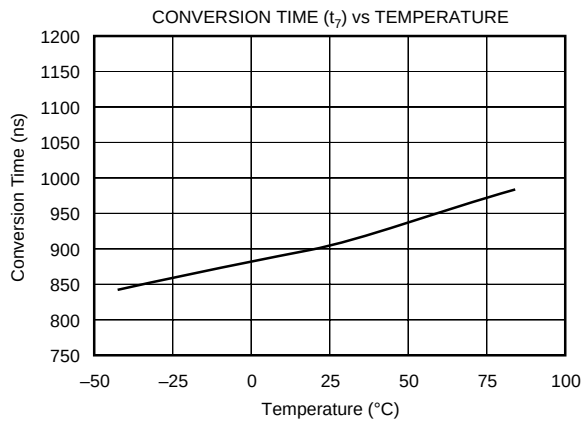
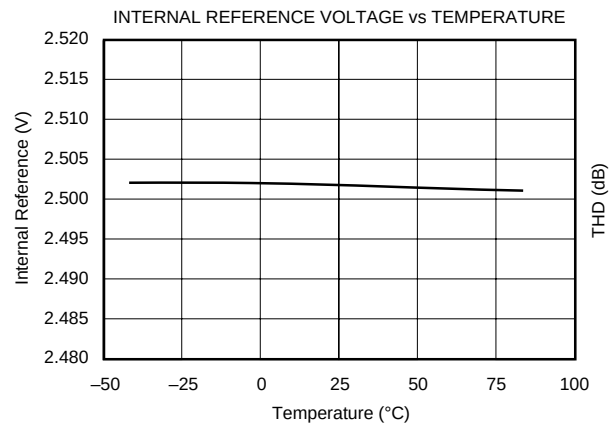
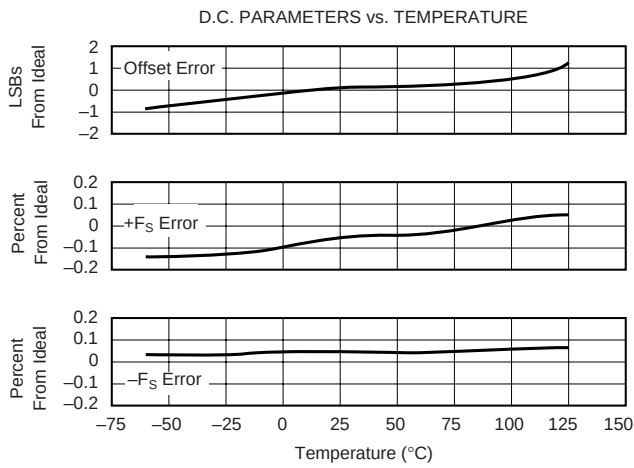
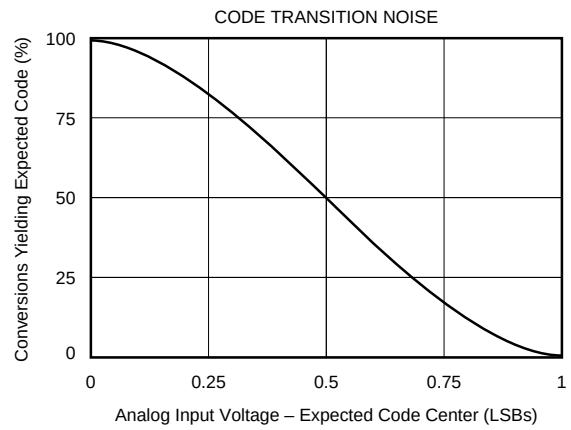
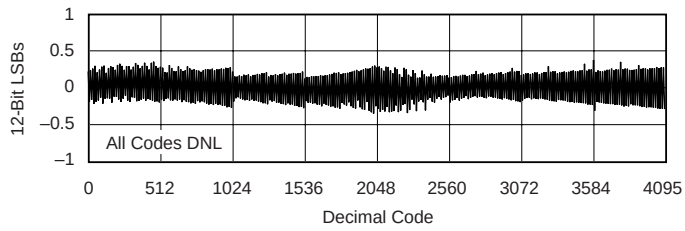
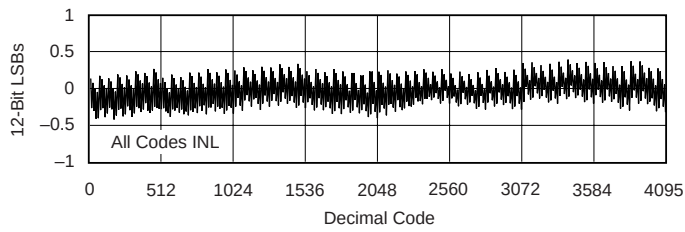
# TYPICAL PERFORMANCE CURVES

T = +25°C,  $f_s = 800\text{kHz}$ ,  $+V_{\text{DIG}} = +V_{\text{ANA}} = +5\text{V}$ ,  $-V_{\text{ANA}} = -5\text{V}$ , using internal reference and the input  $50\Omega$  resistors as shown in Figure 4b, unless otherwise specified.



## TYPICAL PERFORMANCE CURVES (CONT)

$T = +25^{\circ}\text{C}$ ,  $f_S = 800\text{kHz}$ ,  $+V_{\text{DIG}} = +V_{\text{ANA}} = +5\text{V}$ ,  $-V_{\text{ANA}} = -5\text{V}$ , using internal reference and the  $50\Omega$  input resistors as shown in Figure 4b, unless otherwise specified.



## BASIC OPERATION

Figure 1 shows a basic circuit to operate the ADS7810. Taking  $\overline{R/C}$  (pin 23) LOW for a minimum of 40ns will initiate a conversion.  $\overline{BUSY}$  (pin 25) will go LOW and stay LOW until the conversion is completed and the output registers are updated. Data will be output in Binary Two's Complement with the MSB on D11 (pin 6).  $\overline{BUSY}$  going HIGH can be used to latch the data. All convert commands will be ignored while  $\overline{BUSY}$  is LOW.

The ADS7810 will begin tracking the input signal at the end of the conversion. Allowing 1.25μs between convert commands assures accurate acquisition of a new signal.

| $\overline{CS}$ | $\overline{R/C}$ | $\overline{BUSY}$ | OPERATION                                                                                                                       |
|-----------------|------------------|-------------------|---------------------------------------------------------------------------------------------------------------------------------|
| 1               | X                | X                 | None. Databus in Hi-Z state.                                                                                                    |
| ↓               | 0                | 1                 | Initiates conversion. Databus remains in Hi-Z state.                                                                            |
| 0               | ↓                | 1                 | Initiates conversion. Databus enters Hi-Z state.                                                                                |
| 0               | 1                | ↑                 | Conversion completed. Valid data from the most recent conversion on the databus.                                                |
| ↓               | 1                | 1                 | Enables databus with valid data from the most recent conversion.                                                                |
| ↓               | 1                | 0                 | Conversion in progress. Databus in Hi-Z state, enabled when the conversion is completed                                         |
| 0               | ↑                | 0                 | Conversion in progress. Databus in Hi-Z state, enabled when the conversion is completed                                         |
| 0               | 0                | ↑                 | Conversion completed. Valid data from the most recent conversion in the output register, but output pins D11-D0 are tri-stated. |
| X               | X                | 0                 | New convert commands ignored. Conversion in progress.                                                                           |

Table I. Control Line Functions for 'read' and 'convert'.

## STARTING A CONVERSION

The combination of  $\overline{CS}$  (pin 24) and  $\overline{R/C}$  (pin 23) LOW for a minimum of 40ns puts the sample/hold of the ADS7810 in the hold state and starts a conversion.  $\overline{BUSY}$  (pin 25) will go LOW and stay LOW until the conversion is completed and the internal output register has been updated. All new convert commands during  $\overline{BUSY}$  LOW will be ignored.

The ADS7810 will begin tracking the input signal at the end of the conversion. Allowing 1.25μs between convert commands assures accurate acquisition of a new signal. Refer to Table I for a summary of  $\overline{CS}$ ,  $\overline{R/C}$ , and  $\overline{BUSY}$  states and Figures 2 and 3 for timing parameters.

$\overline{CS}$  and  $\overline{R/C}$  are internally OR'd and level triggered. There is not a requirement which input goes LOW first when initiating a conversion. If it is critical that  $\overline{CS}$  or  $\overline{R/C}$  initiate the conversion, be sure the less critical input is LOW at least 10ns prior to the initiating input.

| DESCRIPTION                 | ANALOG VALUE | DIGITAL OUTPUT          |          |
|-----------------------------|--------------|-------------------------|----------|
| Full Scale Range            | ±10V         | BINARY TWO'S COMPLEMENT |          |
| Least Significant Bit (LSB) | 4.88mV       | BINARY CODE             | HEX CODE |
| +Full Scale (10V – 1LSB)    | 9.995V       | 0111 1111 1111          | 7FF      |
| Midscale                    | 0V           | 0000 0000 0000          | 000      |
| One LSB below Midscale      | -4.88mV      | 1111 1111 1111          | FFF      |
| -Full Scale                 | -10V         | 1000 0000 0000          | 800      |

TABLE II. Ideal Input Voltages and Output Codes.

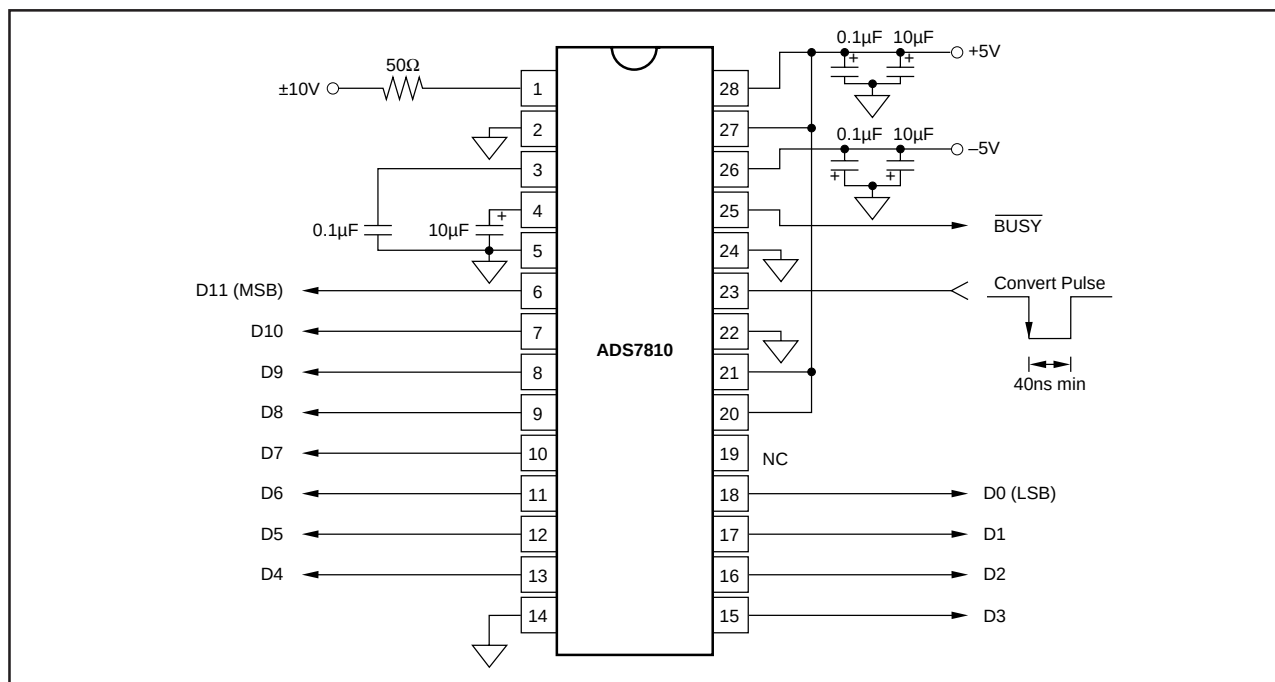


FIGURE 1. Basic Operation

To reduce the number of control pins,  $\overline{CS}$  can be tied LOW using  $R/\overline{C}$  to control the read and convert modes. Note that the parallel output will be active whenever  $R/\overline{C}$  is HIGH and no conversion is in progress. See the Reading Data section and refer to Table I for control line functions for ‘read’ and ‘convert’ modes.

## READING DATA

The ADS7810 outputs full parallel data in Binary Two’s Complement data format. The parallel output will be active when  $R/\overline{C}$  (pin 23) is HIGH,  $\overline{CS}$  (pin 24) is LOW, and no conversion is in progress. Any other combination will tri-state the parallel output. Valid conversion data can be read in a full parallel, 12-bit word on D11-D0 (pins 6-13 and 15-18). Refer to Table II for ideal output codes.

After the conversion is completed and the output registers have been updated,  $BUSY$  (pin 25) will go HIGH. Valid data from the most recent conversion will be available on D11-D0 (pins 6-13 and 15-18).  $BUSY$  going HIGH can be used to latch the data. Refer to Table III and Figures 2 and 3.

Note: For the best performance, the external data bus connected to D11-D0 should not be active during a conversion. The switching noise of the external asynchronous data signals can cause digital feedthrough degrading the converter’s performance.

The number of control lines can be reduced by tying  $\overline{CS}$  LOW while using  $R/\overline{C}$  to initiate conversions and activate the output mode of the converter. See Figure 2.

## INPUT RANGES

The ADS7810 offers a standard  $\pm 10V$  input range. Figures 4a and 4b show the necessary circuit connections for the ADS7810 with and without external trim. Offset and full scale error<sup>(1)</sup> specifications are tested and guaranteed with the  $50\Omega$  resistor shown in Figure 4b. This external resistor makes it possible to trim the offset  $\pm 50mV$  using a trim pot or trim DAC. This resistor may be left out if the offset and gain errors will be corrected in software or if they are negligible in regards to the particular application. See the **Calibration** section of the data sheet for details.

The nominal input impedance of  $3.125k\Omega$  results from the combination of the internal resistor network shown on the front page of the product data sheet and external  $50\Omega$  resistor. The input resistor divider network provides inherent overvoltage protection guaranteed to at least  $\pm 25V$ . The  $50\Omega$ , 1% resistor does not compromise the accuracy or drift of the converter. It has little influence relative to the internal resistors, and tighter tolerances are not required.

Note: The values shown for the internal resistors are for reference only. The exact values can vary by  $\pm 30\%$ . This is true of all resistors internal to the ADS7810. Each resistive divider is trimmed so that the proper division is achieved.

NOTE: (1) Full scale error includes offset and gain errors measured at both +FS and –FS.

| SYMBOL        | DESCRIPTION                                    | MIN  | TYP  | MAX  | UNITS |
|---------------|------------------------------------------------|------|------|------|-------|
| $t_1$         | Convert Pulse Width                            | 40   |      |      | ns    |
| $t_2$         | Data Valid Delay After $R/\overline{C}$ LOW    |      | 955  | 1095 | ns    |
| $t_3$         | $BUSY$ Delay From $R/\overline{C}$ LOW         |      | 70   | 125  | ns    |
| $t_4$         | $BUSY$ LOW                                     |      | 950  | 1080 | ns    |
| $t_5$         | $BUSY$ Delay After End of Conversion           |      | 90   |      | ns    |
| $t_6$         | Aperture Delay                                 |      | 20   |      | ns    |
| $t_7$         | Conversion Time                                |      | 910  | 1020 | ns    |
| $t_8$         | Acquisition Time                               |      | 200  | 230  | ns    |
| $t_7$ & $t_8$ | Throughput Time                                |      | 1110 | 1250 | ns    |
| $t_9$         | Bus Relinquish Time                            | 10   | 50   | 83   | ns    |
| $t_{10}$      | $BUSY$ Delay After Data Valid                  | 20   | 65   | 120  | ns    |
| $t_{11}$      | $R/\overline{C}$ to $\overline{CS}$ Setup Time | 10   |      |      | ns    |
| $t_{12}$      | Time Between Conversions                       | 1250 |      |      | ns    |
| $t_{13}$      | Bus Access Time                                | 10   | 25   | 62   | ns    |

TABLE III. Timing Specifications ( $T_{MIN}$  to  $T_{MAX}$ ).



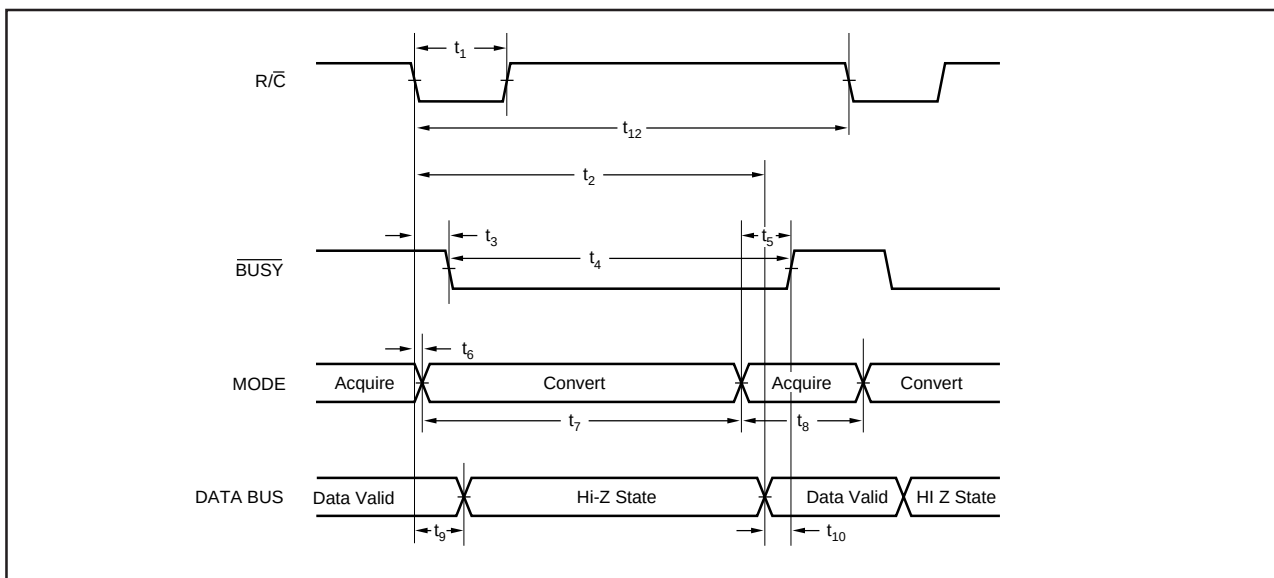


FIGURE 2. Conversion Timing with Outputs Enabled After Conversion ( $\overline{CS}$  Tied Low).

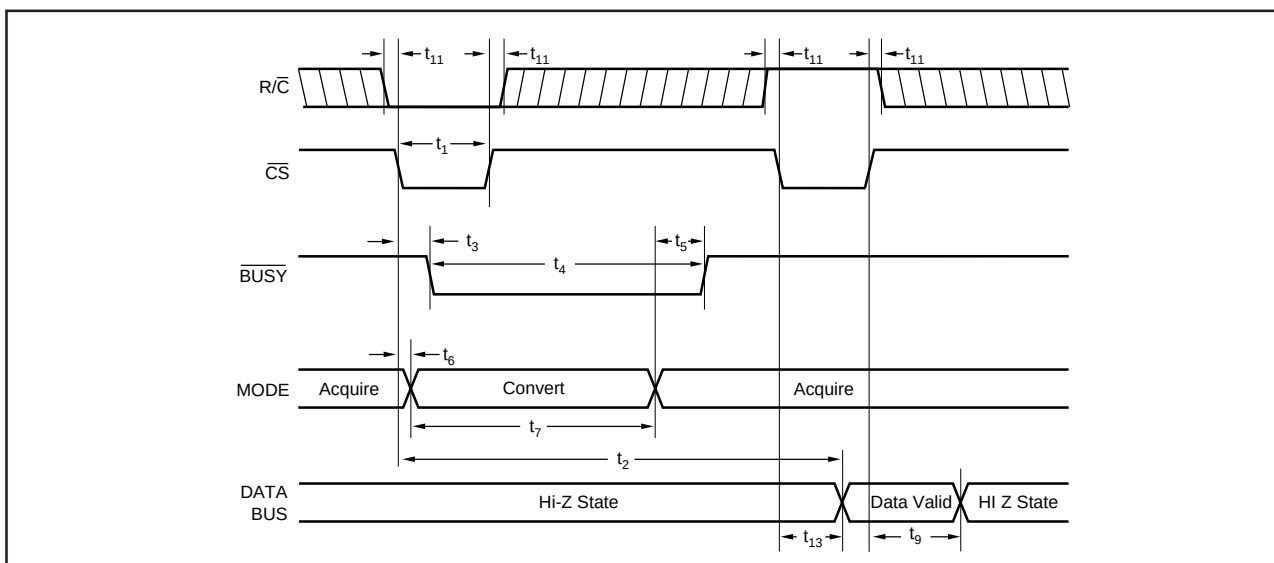


FIGURE 3. Using  $\overline{CS}$  to Control Conversion and Read Timing.

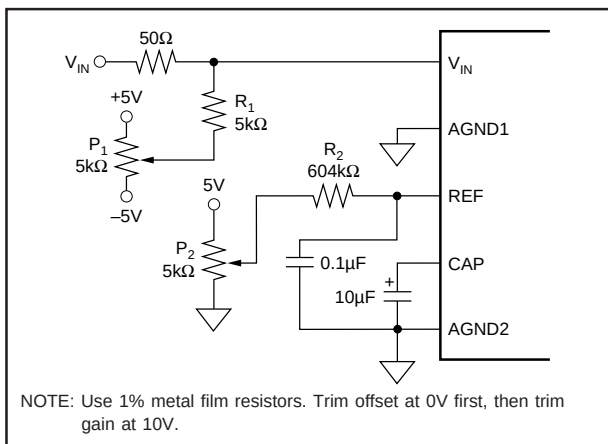


FIGURE 4a. Circuit Diagram With External Hardware Trim.

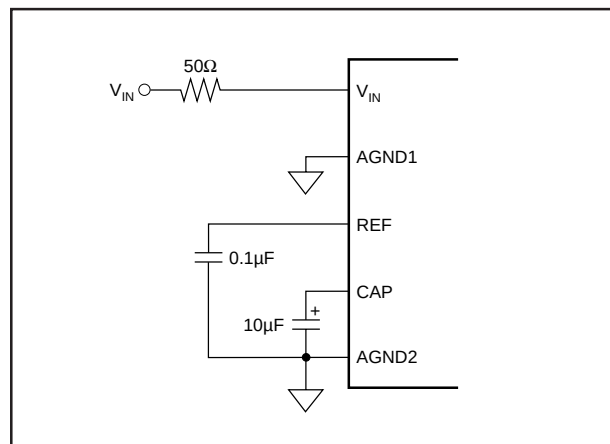


FIGURE 4b. Circuit Diagram Without External Hardware Trim.

## CALIBRATION

The ADS7810 can be trimmed in hardware or software. The offset should be trimmed before the gain since the offset directly affects the gain.

### Hardware Calibration

To calibrate the offset and gain of the ADS7810, install the proper resistors and potentiometers as shown in Figure 4a. The calibration range is  $\pm 50\text{mV}$  for bipolar zero and  $\pm 120\text{mV}$  for full scale.

Potentiometer  $P_1$  and resistor  $R_1$  form the offset adjust circuit and  $P_2$  and  $R_2$  the gain adjust circuit. The exact values are not critical.  $R_1$  and  $R_2$  should not be made any larger than the value shown. They can easily be made smaller to provide increased adjustment range. Reducing these below 15% of the indicated values could begin to adversely affect the operation of the converter.

$P_1$  and  $P_2$  can also be made larger to reduce power dissipation. However, larger resistances will push the useful adjustment range to the edges of the potentiometer.  $P_1$  should probably not exceed  $20\text{k}\Omega$  and  $P_2$   $100\text{k}\Omega$  in order to maintain reasonable sensitivity.

### Software Calibration

To calibrate the offset and gain of the ADS7810, no external resistors are required. See the **No Calibration** section for details on the effects of the external resistor.

### No Calibration

See Figure 4b for circuit connections. Note that the actual voltage dropped across the  $50\Omega$  resistor is nearly two orders of magnitude lower than the voltage dropped across the internal resistor divider network. This should be taken into consideration when choosing the accuracy and drift specifications of the external resistors. In most applications, 1% metal-film resistors will be sufficient.

The external  $50\Omega$  resistor shown in Figure 4b may not be necessary in some applications. This resistor provides trim capability for the offset and compensates for a slight gain adjustment internal to the ADS7810. Not using the  $50\Omega$  resistor will cause a small gain error but will have no effect on the inherent offset error. Figure 5 shows typical transfer function characteristics with and without the  $50\Omega$  resistor in the circuit.

## REFERENCE

The ADS7810 can operate with its internal  $2.5\text{V}$  reference or an external reference. By applying an external reference to pin 3, the internal reference can be bypassed. The reference voltage at REF is buffered internally and output on CAP (pin 4).

### REF

REF (pin 3) is an input for an external reference or the output for the internal  $2.5\text{V}$  reference. A  $0.1\mu\text{F}$  capacitor should be connected as close to the REF pin as possible. The capacitor and the output resistance of REF create a low pass filter to band limit noise on the reference. Using a smaller value capacitor will introduce more noise to the reference degrading the SNR and SINAD. The internal reference should not be used to sink or source currents greater than  $100\mu\text{A}$ . In addition, all external loads should be static.

The range for the external reference is  $2.3\text{V}$  to  $2.7\text{V}$  and determines the actual LSB size. Increasing the reference voltage will increase the full scale range and the LSB size of the converter which can improve the SNR.

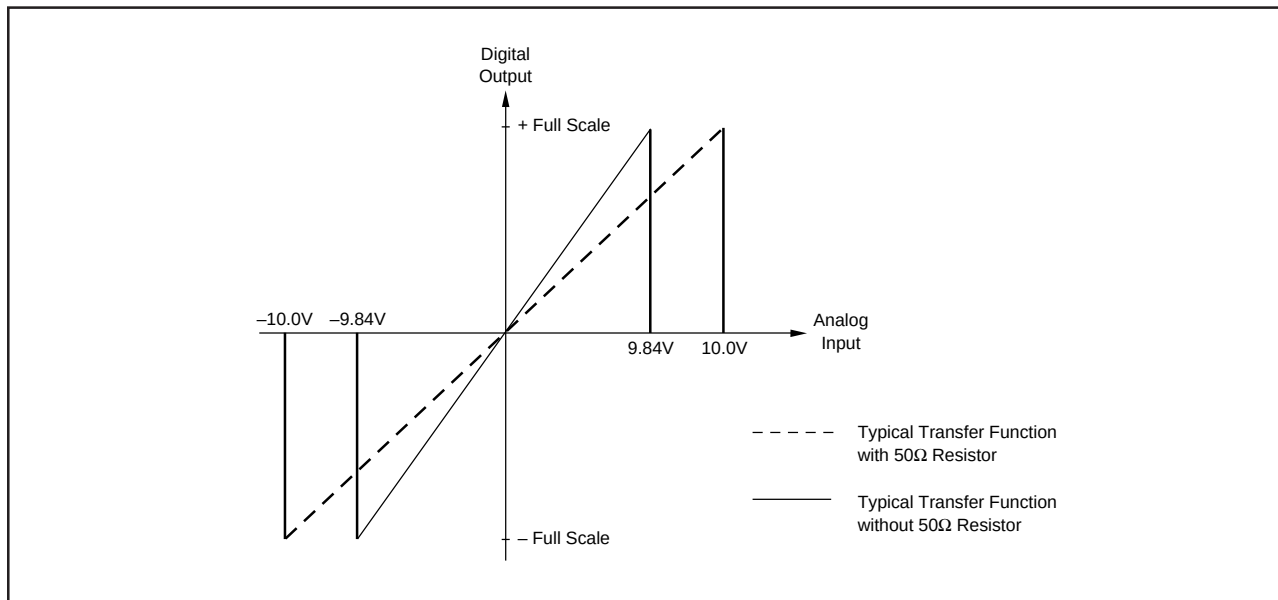


FIGURE 5. Comparison of the ADS7810 Transfer Function With and Without the  $50\Omega$  Series Resistor on  $V_{IN}$ .

## CAP

CAP (pin 4) is the output of the internal reference buffer. A 10 $\mu$ F tantalum capacitor should be placed as close to the CAP as possible to provide optimum switching currents for the CDAC throughout the conversion cycle and compensation for the output of the buffer. Using a capacitor any smaller than 1 $\mu$ F can cause the output buffer to oscillate and may not have sufficient charge for the CDAC. Capacitor values larger than 10 $\mu$ F will have little effect on improving performance. The voltage on the CAP pin is approximately 2V when using the internal reference, or 80% of an externally supplied reference.

## LAYOUT

### POWER

The ADS7810 uses the majority of its power for analog and static circuitry, and it should be considered as an analog component. For optimum performance, tie the analog and digital +5V power pins to the same +5V power supply and tie the analog and digital grounds together.

For best performance, the  $\pm 5$ V supplies can be produced from whatever analog supply is used for the rest of the analog signal conditioning. If  $\pm 12$ V or  $\pm 15$ V supplies are present, simple regulators can be used. The +5V power for the A/D should be separate from the +5V used for the system's digital logic. Connecting +V<sub>DIG</sub> (pin 27) directly to a digital supply can reduce converter performance due to switching noise from the digital logic.

Although it is not suggested, if the digital supply must be used to power the converter, be sure to properly filter the supply. Either using a filtered digital supply or a regulated analog supply, both V<sub>DIG</sub> and V<sub>ANA</sub> should be tied to the same +5V source.

### GROUNDING

Three ground pins are present on the ADS7810. DGND (pin 22) is the digital supply ground. AGND2 (pin 5) is the analog supply ground. AGND1 (pin 2) is the ground which all analog signals internal to the A/D are referenced. AGND1 is more susceptible to current induced voltage drops and must have the path of least resistance back to the power supply.

All the ground pins of the ADS should be tied to the analog ground plane, separated from the system's digital logic ground, to achieve optimum performance. Both analog and digital ground planes should be tied to the "system" ground as near to the power supplies as possible. This helps to prevent dynamic digital ground currents from modulating the analog ground through a common impedance to power ground.

## SIGNAL CONDITIONING

The FET switches used for the sample hold on many CMOS A/D converters release a significant amount of charge injection which can cause the driving op amp to oscillate. The resistive front end of the ADS7810 attenuates this charge and reduces its magnitude significantly—reducing the burden on the external input amplifier or buffer.

However, keep in mind that maintaining signal integrity at voltage swings of  $\pm 10$ V and frequencies of several hundred kilohertz is extremely challenging. In addition, the external input amplifier must drive the ADS7810 mainly during its sample period—roughly 200ns. This will require a high-speed, precision amplifier which can swing to greater than  $\pm 10$ V.

For signals where the predominant frequencies are below 200kHz, the OPA671 operational amplifier should be adequate for most applications. In some cases or where input frequencies are higher, a composite configuration of the OPA671 and BUF634 (in its wide bandwidth mode) may be the best choice. See the BUF634 data sheet for more information.

The resistive front end of the ADS7810 also provides a guaranteed  $\pm 25$ V over voltage protection. In most cases, this eliminates the need for external input protection circuitry.

### INTERMEDIATE LATCHES

The ADS7810 does have tri-state outputs for the parallel port, but intermediate latches should be used if the bus will be active during conversions. If the bus is not active during conversions, the tri-state outputs can be used to isolate the A/D from other peripherals on the same bus.

Intermediate latches are beneficial on any monolithic A/D converter. The ADS7810 has an internal LSB size of 610 $\mu$ V. Transients from fast switching signals on the parallel port, even when the A/D is tri-stated, can be coupled through the substrate to the analog circuitry causing degradation of converter performance.